

28:4 LVDS Transmitter

GENERAL DESCRIPTION

The CS5828 receives four sets of 7-bit data in CMOS logic level and converts them into four low-voltage differential signaling (LVDS) serial channels. The 7-bit input data is referenced to the CKIN signal. The RF pin selects either rising or falling edge trigger of CKIN. Parallel to serial conversion is performed by a 7X internal generated clock reference using on-chip PLL using CKIN. A copy of CKIN but phase-locked to the output serial streams, CLKOUT, is also converted to the fifth LVDS channel. The CS5828 offers a reliable communication media using LVDS signaling and provides low EMI dealing with wide, high-speed TTL interfaces.

This is especially attractive for interfaces between GUI controller and display systems such as LCD panels for SVGA/XGA/SXGA applications.

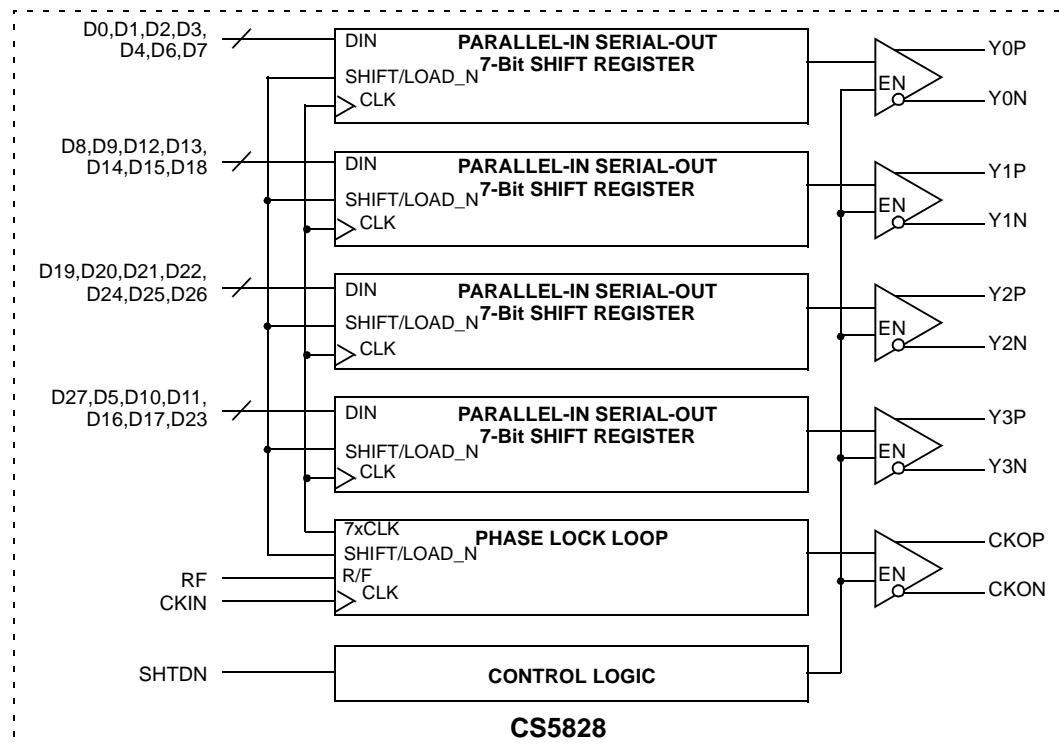
FEATURES

- Four 7-bit serial and one clock LVDS channels.
- Compatible with ANSI TIA/EIA-644 LVDS standard.
- Wide CKIN ranges from 31MHz to 85MHz.
- Fully integrated on-chip PLL that provides 7X CKIN serial shift clock.
- Pin selectable for rising or falling edge trigger.
- Support power-down mode.
- 5V/3.3V tolerant data input.
- Single 3.3V supply operation.
- CMOS low power consumption.
- Functional compatible with DS90C385.
- Available in 56-pin TSSOP package.

BLOCK DIAGRAM

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PIN CONNECTION DIAGRAM

VDD	<input type="checkbox"/> 1	56	<input type="checkbox"/>	D4
D5	<input type="checkbox"/> 2	55	<input type="checkbox"/>	D3
D6	<input type="checkbox"/> 3	54	<input type="checkbox"/>	D2
D7	<input type="checkbox"/> 4	53	<input type="checkbox"/>	VSS
VSS	<input type="checkbox"/> 5	52	<input type="checkbox"/>	D1
D8	<input type="checkbox"/> 6	51	<input type="checkbox"/>	D0
D9	<input type="checkbox"/> 7	50	<input type="checkbox"/>	D27
D10	<input type="checkbox"/> 8	49	<input type="checkbox"/>	LVDS_VSS
VDD	<input type="checkbox"/> 9	48	<input type="checkbox"/>	Y0M
D11	<input type="checkbox"/> 10	47	<input type="checkbox"/>	Y0P
D12	<input type="checkbox"/> 11	46	<input type="checkbox"/>	Y1M
D13	<input type="checkbox"/> 12	45	<input type="checkbox"/>	Y1P
VSS	<input type="checkbox"/> 13	44	<input type="checkbox"/>	LVDS_VDD
D14	<input type="checkbox"/> 14	43	<input type="checkbox"/>	LVDS_VSS
D15	<input type="checkbox"/> 15	42	<input type="checkbox"/>	Y2M
D16	<input type="checkbox"/> 16	41	<input type="checkbox"/>	Y2P
RF	<input type="checkbox"/> 17	40	<input type="checkbox"/>	CKOM
D17	<input type="checkbox"/> 18	39	<input type="checkbox"/>	CKOP
D18	<input type="checkbox"/> 19	38	<input type="checkbox"/>	Y3M
D19	<input type="checkbox"/> 20	37	<input type="checkbox"/>	Y3P
VSS	<input type="checkbox"/> 21	36	<input type="checkbox"/>	LVDS_VSS
D20	<input type="checkbox"/> 22	35	<input type="checkbox"/>	PLL_VSS
D21	<input type="checkbox"/> 23	34	<input type="checkbox"/>	PLL_VDD
D22	<input type="checkbox"/> 24	33	<input type="checkbox"/>	PLL_VSS
D23	<input type="checkbox"/> 25	32	<input type="checkbox"/>	SHTDN
VDD	<input type="checkbox"/> 26	31	<input type="checkbox"/>	CKIN
D24	<input type="checkbox"/> 27	30	<input type="checkbox"/>	D26
D25	<input type="checkbox"/> 28	29	<input type="checkbox"/>	VSS

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Figure-1 56-pin TSSOP

PIN DESCRIPTION

Name	I/O	Description
D0,D1,D2,D3,D4, D6,D7	I	Parallel data input for Y0 LVDS channel. D[0] is LSB and D[7] is MSB. MSB is shifted out first.
D8,D9,D12,D13, D14,D15,D18	I	Parallel data input for Y1 LVDS channel. D[8] is LSB and D[18] is MSB.
D19,D20,D21,D22 ,D24,D25,D26	I	Parallel data input for Y2 LVDS channel. D[19] is LSB and D[26] is MSB.
D27,D5,D10,D11, D16,D17,D23	I	Parallel data input for Y3 LVDS channel. D[27] is LSB and D[23] is MSB.
CKIN	I	Parallel input clock. This clock signal is used for parallel data reference. It is also used by the on-chip PLL to generate the 7X shift clock for parallel to serial conversion.
RF	I	Rise/fall select. This pin selects the polarity of the CKIN edge for data input. RF = 1 selects CKIN rise edge, and RF = 0 selects CKIN fall edge.
SHTDN	I	Shutdown control (low active). When SHTDN is low, the internal PLL is put into inhibit mode and all LVDS output channels are shut off. This also resets all internal registers. For normal operation, SHTDN should be set to high.
Y0P, Y0N	O	Y0 LVDS channel output. These are differential LVDS outputs for Y0 channel corresponds to D0, D1, D2, D3, D4, D6, D7.
Y1P, Y1N	O	Y1 LVDS channel output. These are differential LVDS outputs for Y1 channel corresponds to D8, D9, D12, D13, D14, D15, D18.
Y2P, Y2N	O	Y2 LVDS channel output. These are differential LVDS outputs for Y2 channel corresponds to D19, D20, D21,D22, D24, D25, D26.
Y3P, Y3N	O	Y3 LVDS channel output. These are differential LVDS outputs for Y3 channel corresponds to D27, D5, D10, D11, D16, D17, D23.
CKOP, CKON	O	Clock LVDS channel output. These are differential LVDS output for the replica of CKIN signal. CKOP and CKON are derived from the internal phase lock loop and phase aligned with the serial data output and can be used by the LVDS receiver for reference edge.
PLL_VDD	P	Power supply for PLL circuit.
PLL_VSS	P	Power ground for PLL circuit.
LVDS_VDD	P	Power supply for output buffer circuits.
LVDS_VSS	P	Power ground for output buffer circuits.
VDD	P	Power supply for internal circuits.
VSS	P	Power ground for internal circuits.

FUNCTIONAL DESCRIPTION

Control logic

There are two modes in this circuit. One is normal mode, and another is power down mode. Two modes are controlled by the control signal “SHTDN”. If SHTDN is high, the circuit is in the normal mode, else if low, the circuit is in the power down mode. In the power down mode, every block is off to make sure the least power consumption.

7 x CLK PLL

7 x CLK PLL, which is a phase lock loop, generates seven times clock of CKIN. The signal “RF” indicates that the input data (D0 ~ D27) is rising edge or falling edge trigger by CKIN. If RF=1, it is rising edge trigger, else if RF=0, it is falling trigger. This seven times clock of CKIN is used by the Parallel ~ LOAD 7 Bit shift Register. 7 x CLK PLL also generate the control signal “SHIFT/LOAD”. This signal is also used by the Parallel ~ LOAD 7 Bit Shift Register to indicate when to load data or shift data.

Parallel ~ LOAD 7 Bit shift Register

This block transfers 7 bits parallel data into one bit series data out. It is controlled by SHIFT/LOAD. If this control signal is low, the data are loaded into shift registers. Next, the SHIFT/LOAD turns high to shift data from shift register to output buffer seven times. One load and then seven shift.

Ref:

There are two properties in this block. One is that it supports reference voltage to fine the output's common mode voltage. Another is that it generates about (4ns ~6ns) pulse width's power on reset signal. When power on, all block would be reset by power on reset signal to make sure that the circuit would not stuck-at some situation we do not care.

There are four data output buffers and one clock output buffer. Output buffer generates differential pair output that swing is under 500 ~ 900mV, and common-mode voltage is under 1.125V ~ 1.375V.



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RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply voltage	3	3.3	3.6	V
V_{IH}	High-level input voltage	2	-	-	V
V_{IL}	Low-level input voltage	-	-	0.8	V
Z_L	Differential load impedance	90	-	132	Ω
T_A	Operating free-air temperature	0	-	70	$^{\circ}\text{C}$

TIMING REQUIREMENTS

Symbol	Parameter	Min	Typ	Max	Unit
t_C	Input clock period	11.76		32.4	ns
t_W	Pulse duration, high-level input clock	$0.4t_C$		$0.6t_C$	ns
t_t	Transition time, Input signal			5	ns
t_{su}	Setup time, data, D0~D27 valid before CKIN↓ (RF = 0) or CKIN↑(RF = 1)	3			ns
t_h	Hold time, data, D0~D27 valid after CKIN↓ (RF = 0) or CKIN↑(RF = 1)	1.5			ns



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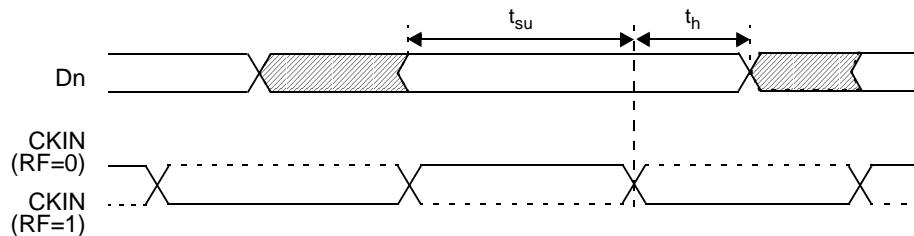
DC CHARACTERISTICS

Symbol	Parameter	Condition	Min	Typ	Max	Unit
V_{IT}	Input threshold voltage		-	1.4	-	V
$ V_{OD} $	Differential steady-state output voltage magnitude	$R_L = 100\Omega$	247	340	454	mV
$\Delta V_{OD} $	Change in the steady-state differential output voltage magnitude between opposite binary states		-	10	50	mV
$V_{OC(ss)}$	Steady-state common-mode output voltage		1.125	-	1.375	V
$V_{OC(PP)}$	Peak-to-peak common-mode output voltage		-	80	150	mV
I_{IH}	High-level input current	$V_{IH} = V_{CC}$	-	-	20	μA
$I_{IH-SHTDN}$	High level input current for SHTDN pin	$V_{IH} = V_{CC}$	-	-	10	μA
I_{IL}	Low-level input current	$V_{IL} = 0$	-	-	± 10	μA
I_{OS}	Short-circuit output current	$V_{O(Y_n)} = 0$	-	-	± 24	mA
		$V_{OD} = 0$	-	-	± 12	mA
I_{OZ}	High-impedance output current	$V_O = 0$ to V_{CC}	-	-	± 10	μA
$I_{CC(AVG)}$	Quiescent supply current (average)	Power down SHTDN = 0	-	-	250	μA
		Enabled, $R_L = 100\Omega$ (4 places) Gray-scale pattern $V_{CC} = 3.3V$, $t_C = 11.76ns$	-	40	60	mA
		Enabled, $R_L = 100\Omega$ (4 places) Worst-case pattern $t_C = 11.76ns$	-	50	75	mA
C_I	Input capacitance		-	3	-	pF

Note: All typical values are at $V_{CC} = 3.3V$, $T_A = 25^\circ C$.

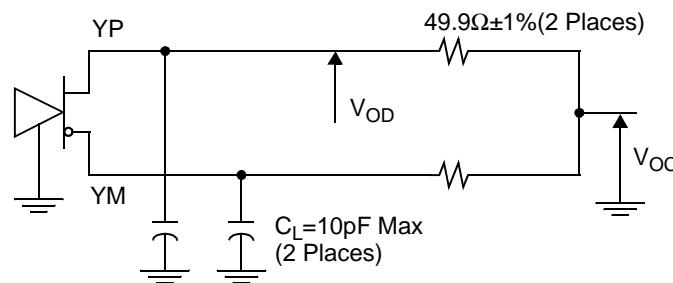
AC CHARACTERISTICS

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t_0	CKO \uparrow to bit 0	$T_c = 11.76 \text{ ns}$	-0.2	0	0.2	ns
t_1	CKO \uparrow to bit 1		$1/7t_c - 0.2$	-	$1/7t_c + 0.2$	ns
t_2	CKO \uparrow to bit 2		$2/7t_c - 0.2$	-	$2/7t_c + 0.2$	ns
t_3	CKO \uparrow to bit 3		$3/7t_c - 0.2$	-	$3/7t_c + 0.2$	ns
t_4	CKO \uparrow to bit 4		$4/7t_c - 0.2$	-	$4/7t_c + 0.2$	ns
t_5	CKO \uparrow to bit 5		$5/7t_c - 0.2$	-	$5/7t_c + 0.2$	ns
t_6	CKO \uparrow to bit 6		$6/7t_c - 0.2$	-	$6/7t_c + 0.2$	ns
t_{skew}	Output skew		-0.2	-	0.2	ns
$\Delta t_c(o)$	Cycle time, Output clock jitter		-	± 100	-	ps
t_w	Pulse duration, high-level output clock		-	$4/7t_c$	-	ns
t_t	Transition time, differential output voltage (t_r or t_f)		260	700	1500	ps
t_{enable}	Enable time, SHTDN \uparrow to phase lock (Yn valid)		-	1	-	ms
t_{disable}	Disable time, SHTDN \downarrow to off state (CKO low)		-	250	-	ns



Note: Maximum value of t_r , $t_f = 5\text{ns}$

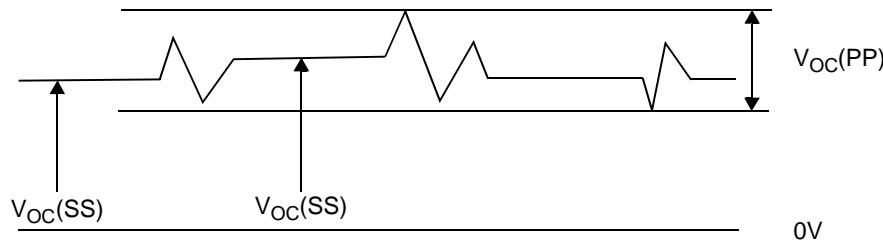
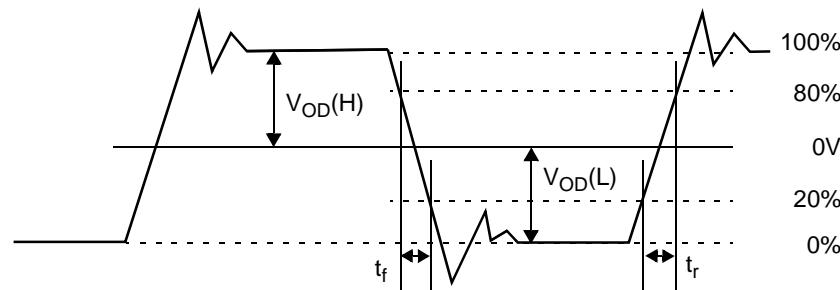
Figure-2 Setup and Hold Time Definition



(a) SCHEMATIC

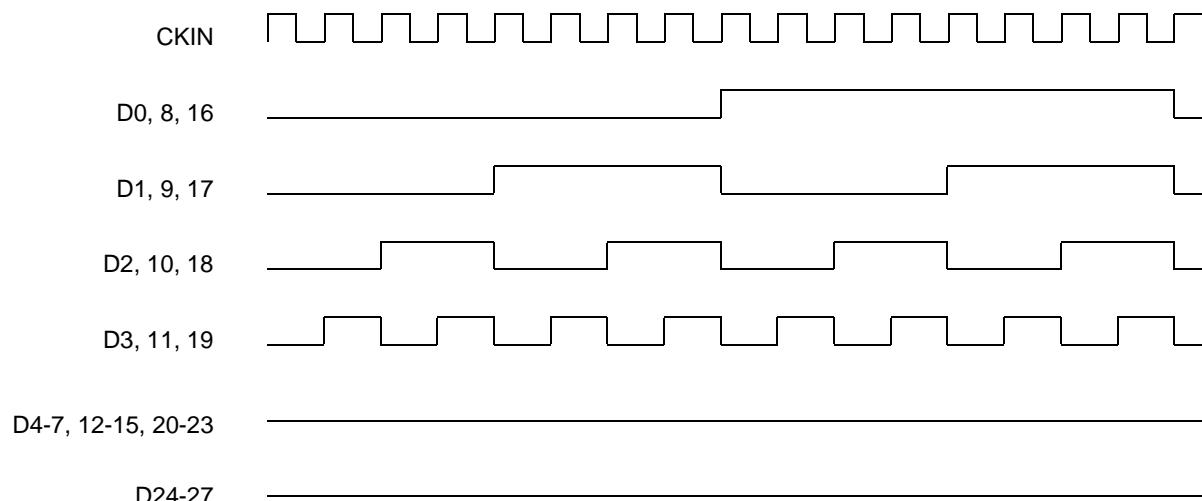
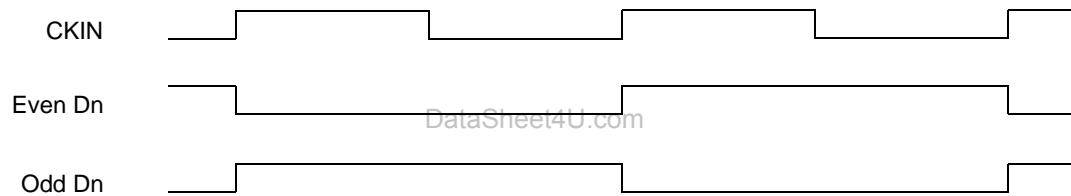
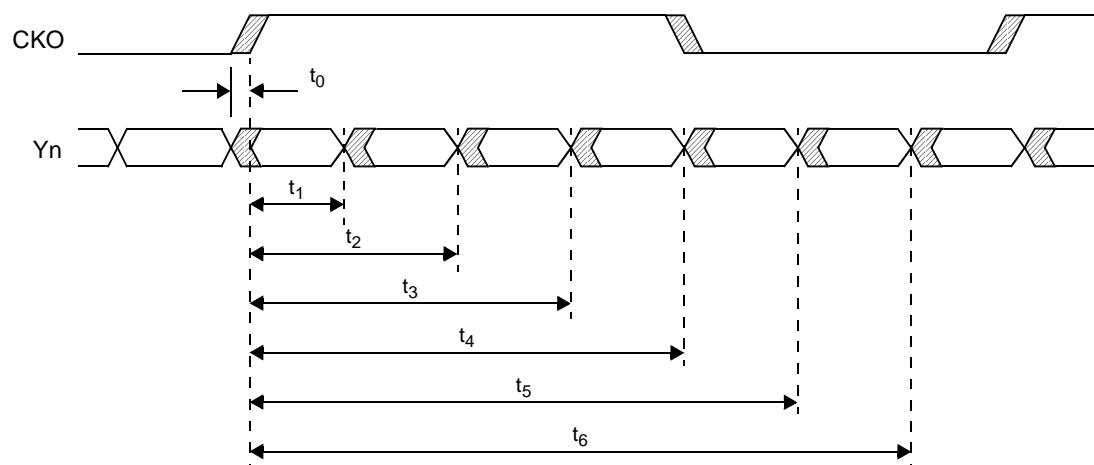
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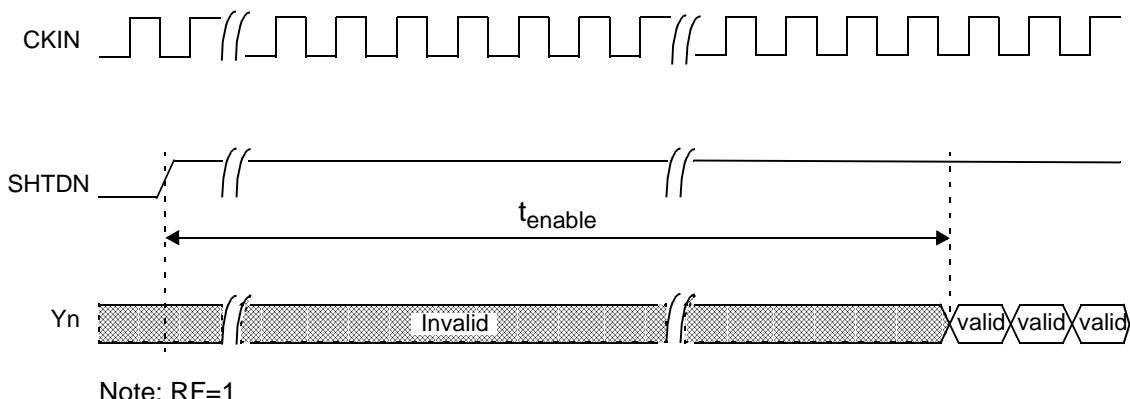
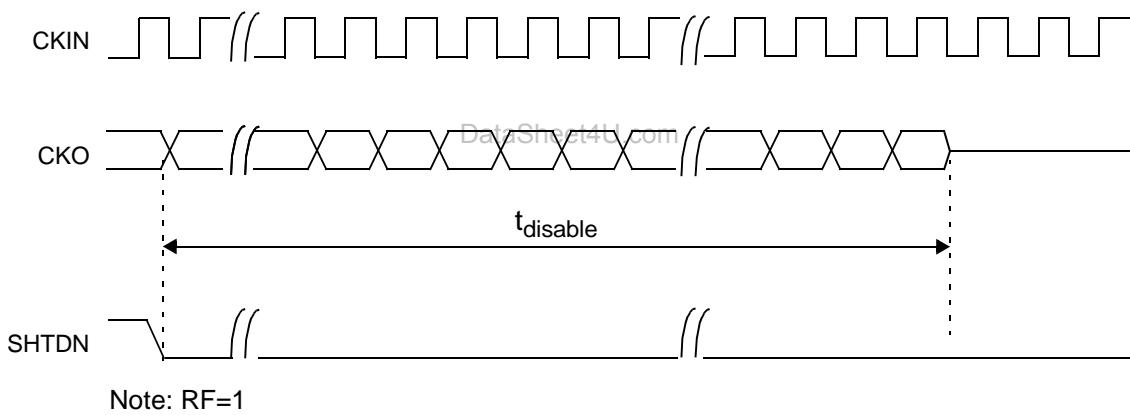
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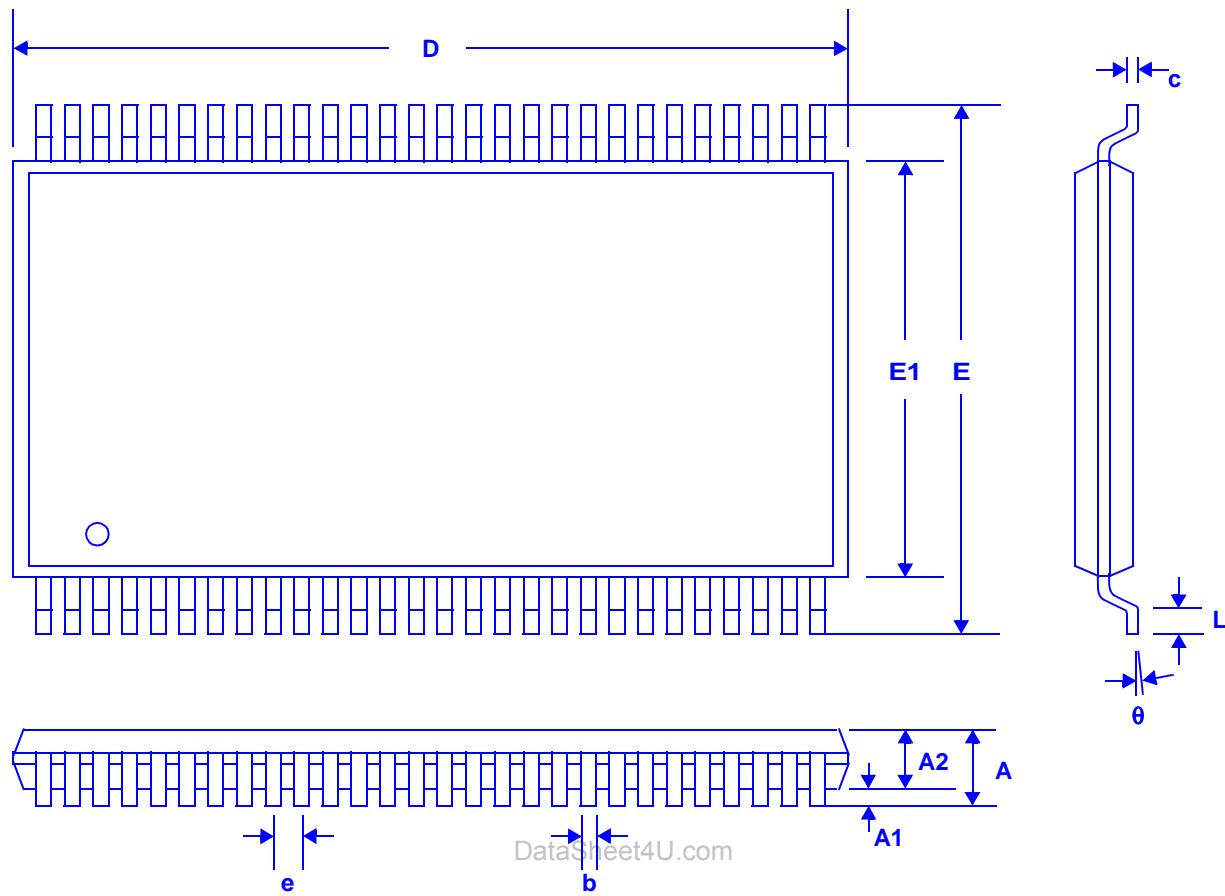


(b) WAVEFORMS

Figure-3 Test Load and Voltage Definitions for LVDS Outputs

TEST PATTERN**Figure-4 16-Grayscale Testing Pattern Waveforms****Figure-5 The Worst-case Testing Pattern Waveforms****Figure-6 Timing Waveform's Definitions**

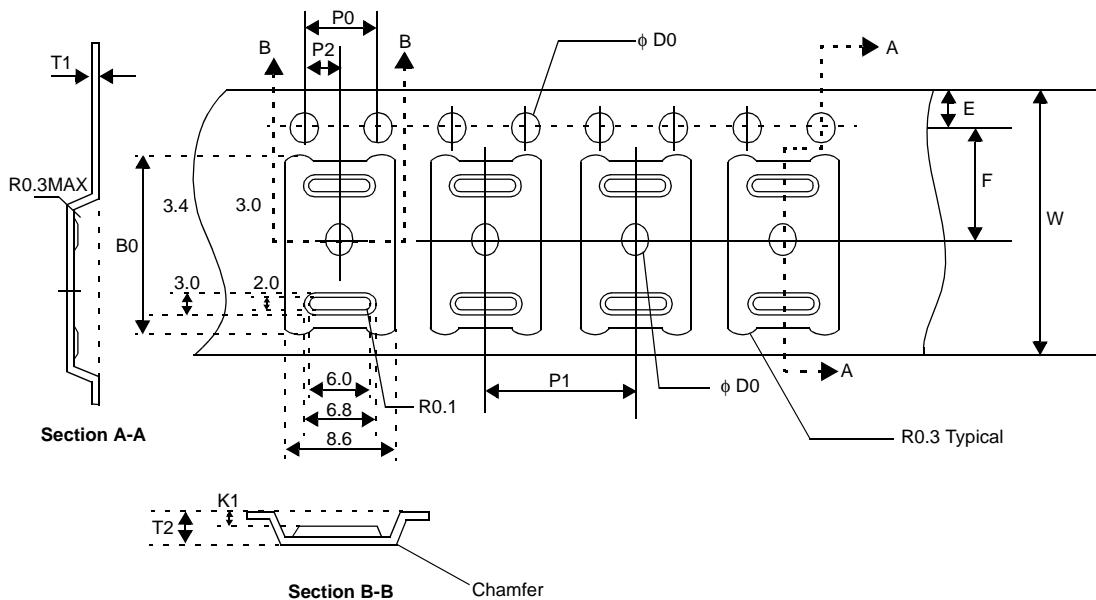
TYPICAL CHARACTERISTICS**Figure-7 Enabled Time Waveforms****Figure-8 Disabled Time Waveforms**

PACKAGE OUTLINE (56-pin TSSOP)

Symbol	Dimensions in Millimeters			Dimensions in Inches		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.05	-	1.20	0.041	-	0.047
A1	0.05	-	0.15	0.002	-	0.006
A2	-	0.90	-	-	0.035	-
b	0.17	0.20	0.27	0.007	0.008	0.010
c	0.09	0.15	0.20	0.004	0.006	0.008
D	13.90	14.00	14.10	0.547	0.551	0.555
E	7.80	8.10	8.40	0.307	0.319	0.330
E1	6.00	6.10	6.20	0.236	0.240	0.244
e	-	0.50	-	-	0.0197	-
L	0.50	-	0.75	0.020	-	0.030
θ	0°	-	7°	0°	-	7°

Note: The CS5828 products keep using the original Century logo.

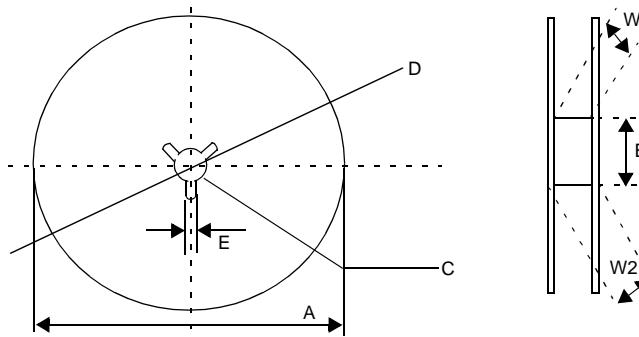


PACKAGING SPECIFICATION

Dimension

Symbol	B0	φ D0	E	F	K1	P0	P1	P2	T1	T2	W
Unit: mm	14.5	1.5 +0.1 -0	1.75 ±0.1	11.5 ±0.05	1.3 Max	4 ±0.2	12.0 ±0.1	2 ±0.05	0.3 ±0.05	1.8 Max	24.0 ±0.3

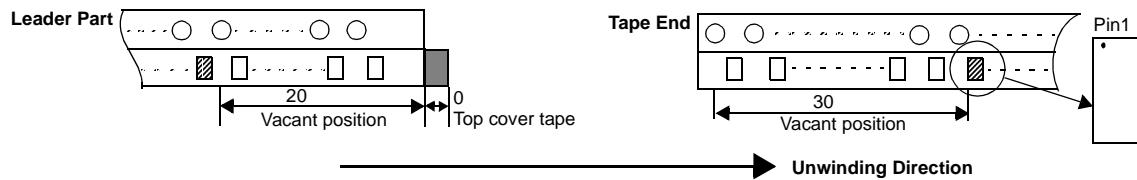
Standard Packing Quantity

Carrier Tape Width	Reel Size	Pocket Pitch	Leader No. of Pockets	End No. of Pockets	Quantity (Pcs/Reel)
24mm	φ330mm	4mm	20	30	2500

Reel For Taping


Unit: mm

A	B	C	D	E	W1	W2
φ 330 +1 -4	φ100 ±0.1	13 +0.5 -0.2	20.2 ±0.8	2.0 ±0.5	24.8 +0.3 -0.2	30.2 Max

Leader Part And Taped End**Approval Supplier For Packing Material**

Item	Supplier
Carrier Tape	ADVANTEK
Cover Tape	ADVANTEK
Plastic Reel	ADVANTEK

Ordering Information**Part Number**

Prefix	Part Type	Package Type
CS	5828	N:TSSOP